



60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on)	I _D T _C = +25°C (Note 9)
60V	6.5mΩ @ V _{GS} = 10V	100A
60 V	$10m\Omega$ @ V _{GS} = 4.5V	81.6A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Engine management systems
- Body control electronics
- DC-DC converters

Features

- Rated to +175°C —Ideal for High Ambient Temperature **Environments**
- 100% Unclamped Inductive Switching (UIS) Test in Production-Ensures More Reliable and Robust End Application
- Low RDS(ON)—Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH6006LPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

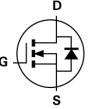
- Package: PowerDI®5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)

PowerDI5060-8 (SWP) (Type Q)



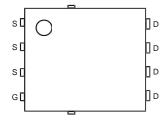
Top View

Bottom View



Internal Schematic

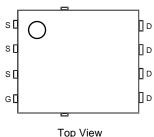
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Top View Pin Configuration



Internal Schematic



Pin Configuration

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Ordering Information (Note 4)

Part Number	Daakana	Packing		
Fait Number	Package	Qty.	Carrier	
DMTH6006LPSWQ-13	PowerDI5060-8 (SWP) (Type Q)	2500	Tape & Reel	
DMTH6006LPSWQ-13	PowerDI5060-8/SWP (Type UX)	2500	Tape & Reel	

Note: 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



TH6006LSW = Product Type Marking Code
YYWW or YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 23 = 2023)
WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	60	V	
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current, VGS = 10V (Note 5)	$T_A = +25^{\circ}C$ $T_A = +100^{\circ}C$	lo	17.2 12.1	А
Continuous Drain Current, V _{GS} = 10V (Notes 6 & 9)	T _C = +25°C T _C = +100°C	lo	100 71.6	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	400	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	100	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycl	I _{SM}	400	Α	
Avalanche Current, L=0.1mH		las	28.5	А
Avalanche Energy, L=0.1mH		Eas	40.7	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P _D	2.88	W
Thermal Resistance, Junction to Ambient (Note 5)		Rөja	52	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	100	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1.5	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

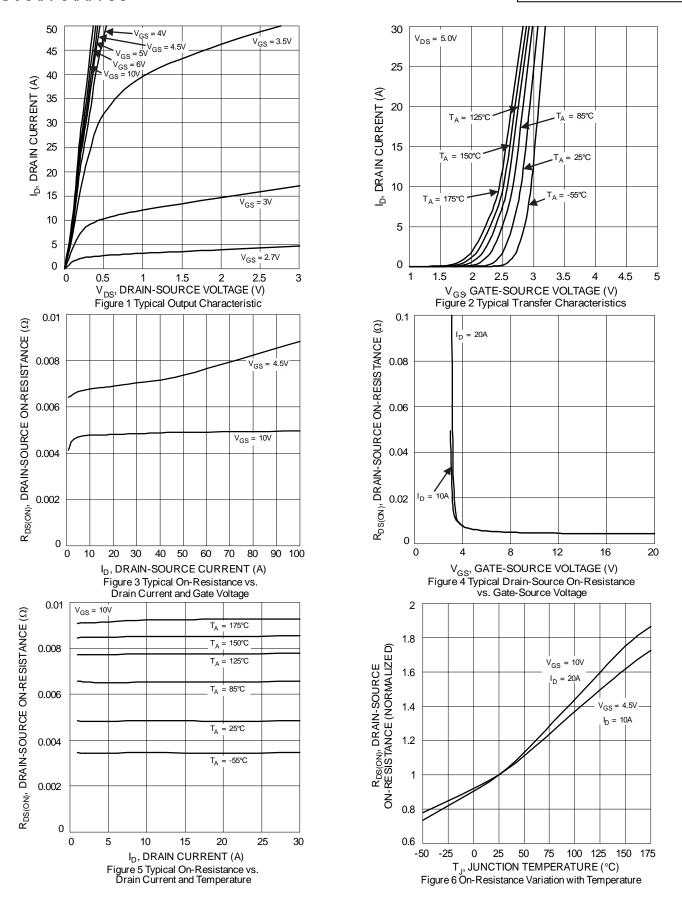
Characteristic	Symbol	Min	Tyrn	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	Syllibol	IVIIII	Тур	IVIAX	Unit	rest Condition	
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	Ipss	_	_	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS			±100	nΑ	$V_{GS} = 48V, V_{GS} = 0V$ $V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	IGSS			±100	IIA	VGS = ±20V, VDS = 0V	
	1 1/	4.0		2.5	17	V V I 050::A	
Gate Threshold Voltage	VGS(TH)	1.2	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Process	_	4.9	6.5	mΩ	$V_{GS} = 10V, I_{D} = 20A$	
Static Drain-Source On-Nesistance	RDS(ON)	_	7.1	10	11122	$V_{GS} = 4.5V, I_{D} = 10A$	
Diode Forward Voltage	VsD	_	0.8	1.2	V	V _G S = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	2162	_		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	761	_	pF		
Reverse Transfer Capacitance	Crss	_	58	_			
Gate Resistance	R_g	_	0.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	18.1	_			
Total Gate Charge (Vgs = 10V)	Qg	_	34.9	_	nC	V _{DS} = 30V, I _D = 20A	
Gate-Source Charge	Qgs	_	6.1	_	iiC		
Gate-Drain Charge	Q_{gd}	_	7.3	_			
Turn-On Delay Time	tD(ON)	_	6.0	_			
Turn-On Rise Time	t _R	_	5.4	_	20	$V_{DD} = 30V, V_{GS} = 10V,$	
Turn-Off Delay Time	tD(OFF)	_	20.4	_	ns	$I_D = 20A$, $R_g = 3\Omega$	
Turn-Off Fall Time	tF	_	7.8	_			
Body Diode Reverse Recovery Time	t _{RR}	_	35.8	_	ns	1 200 1:/-14 4000/	
Body Diode Reverse Recovery Charge	QRR	_	40.2	_	nC	I _F = 20A, di/dt = 100A/μs	

Notes:

- 5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 6. Thermal resistance from junction to soldering point (on the exposed drain pad).7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.
- 9. Limited by package.

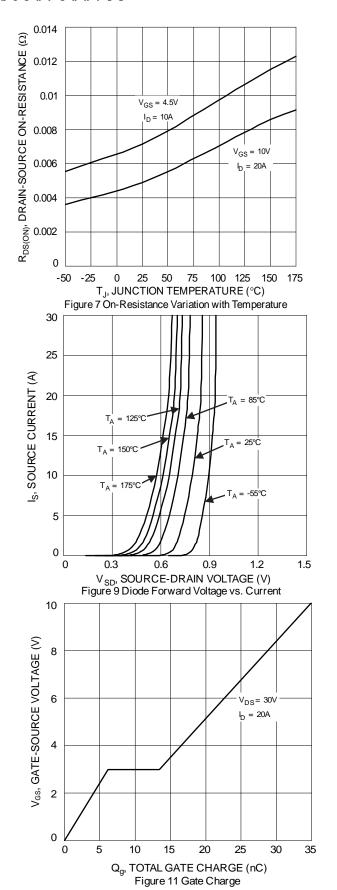


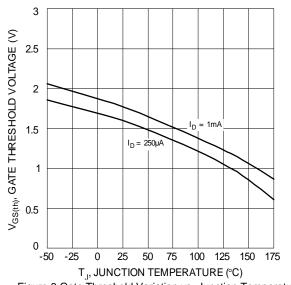


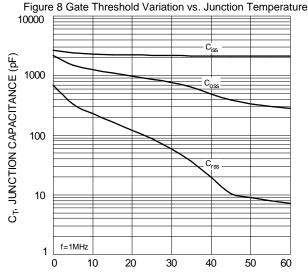


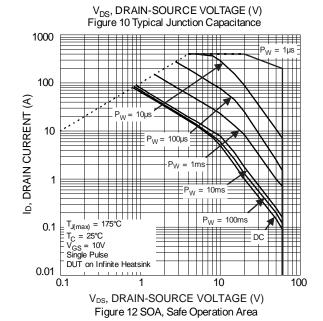




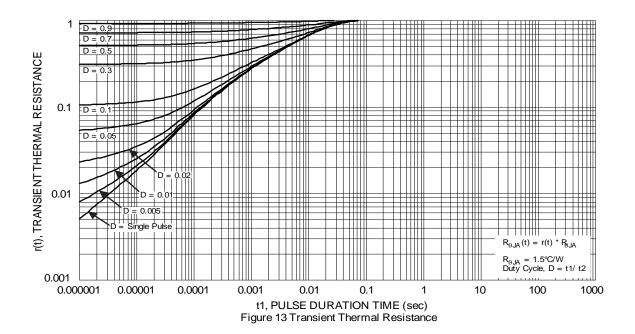










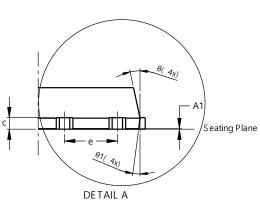




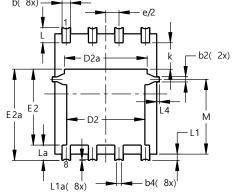
Package Outline Dimensions

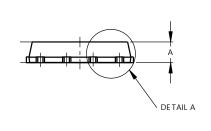
Please see http://www.diodes.com/package-outlines.html for the latest version.

1.900 D1 E1 E 00.986 Depth 0.07±0.030



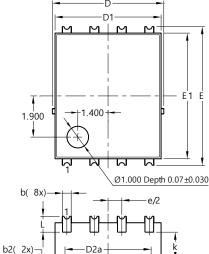
PowerDI5060-8 (SWP) (Type Q)

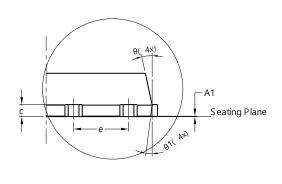


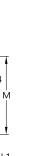


PowerDI5060-8 (SWP) (Type Q) Dim Min Max Тур 0.90 1.10 1.00 **A1** 0 0.05 b 0.30 0.50 0.41 0.25 b2 0.20 0.35 0.25REF b4 С 0.230 | 0.330 | 0.277 D 5.15 BSC D1 5.10 4.70 4.90 D2 3.56 3.96 3.76 D2a 3.78 4.18 3.98 Ε 6.40 BS0 E1 5.60 6.00 5.80 E2 3.46 3.86 3.66 E2a 4.195 4.595 4.395 1.27BS0 е k 1.05 L 0.635 0.835 0.735 La 0.635 0.835 0.735 L1 0.200 0.400 0.300 0.050REF L1a L4 0.025 0.225 0.125 M 3.205 4.005 3.605 θ 12° 10° 11° 6 All Dimensions in mm

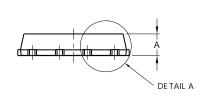
PowerDI5060-8/SWP (Type UX)







-b4(8x)



DETAIL A

PowerDI5060-8/SWP					
(Type UX)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A 1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	().25REF	-		
С	0.230	0.330	0.277		
D		.15 BS0			
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	4.18	3.98		
Е	6	.40 BS0			
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1.27BSC				
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L1a	0.050REF				
L4	0.025	0.225	0.125		
M	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

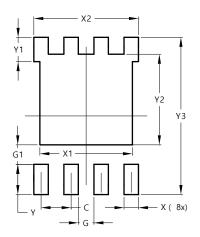
| E2 | E2a |



Suggested Pad Layout

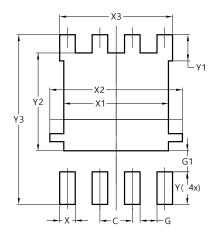
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PowerDI5060-8 (SWP) (Type Q)



Dimensions	Value
Dillielisions	(in mm)
C	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	4.420
Y	1.270
Y1	1.020
Y2	3.810
Y3	6.610

PowerDI5060-8/SWP (Type UX)



Dimensions	Value
	(in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	5.190
Х3	4.420
Υ	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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